Radiation Hardness of High Resistivity CZ Si Detectors after Gamma, Neutron and Proton Radiations

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OUTLINE

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Introduction

- Oxygenated (HTLT and DOFZ) Si detectors are more rad hard to charged particles and gamma than STD FZ detectors
- [O] in oxygenated Si: in the 10¹⁷'s /cm³
- [O] in STD FZ Si: in the 10¹⁵'s /cm³
- [O] in CZ Si: in the 10¹⁸'s /cm³ Comes naturally from wafer manufacture process Resistivity ≤100 Ω-cm Thermal donor (TD) a problem
- Magnetic CZ technology now available: High [O] High resistivity ≥1000 Ω-cm : almost detector grade
- Is MCZ Si detector more radiation hard than Oxy Si? Gamma radiation could offer a clear clue How about to neutrons and protons?

Review of gamma radiation results on STD and Oxy detectors

- Oxygenated Si detectors have shown, as compared to STD ones (in terms of N_{eff}):
 - Partially rad-hardness improvement with charged particles radiation
 - Almost insensitive to gamma radiation
 - Little/no rad-hardness improvement with neutron radiation



- **Recent results have shown in fact there is a slight increase in** positive space charge in Oxy Si detectors with gamma dose:
 - NO SCSI in Oxy Si detectors
 - Positive space charge build-up may be due to the activation of thermal donors



Z. Li et al., Presented on 4th Intern. Conf. on Rad. Effects on Semicond.

D (Mrad)

For more details also from talks of E. Verbitskaya and E. Fretwurst on this Work shop.

Experimental

• Samples

Control FZ (CFZ) samples and some MCZ samples processed together by Univ. of Helsinki, and some MCZ samples were processed by BNL Oxidation: 8+5 hours in O₂ at 1050 °C, all diodes are p⁺/n/n⁺ junctions

Wafer #	Туре	Resistivity (Ω-cm)	Thickness (µm)
T15, 1	CFZ	3000	520
O6, 3	MCZ	1200	380

Various square diodes of 0.36 cm² each from each wafer were used

Radiation

60Co gamma: E = 1.25 MeV; Dose rate: 0.5 Mrad/hr; Dose range: 0-1.2 Grad

Neutrons: <E>=1 MeV; fluence: 0 to 2.9x10¹⁴ n/cm²

Protons: 10 MeV and 20 MeV; fluence: 0 to 1.2x10¹⁴ p/cm²

Measurements

C-V measurements at RT and 100 kHz TCT measurements using a red laser

Results and Discussions

• C-V measurements CFZ:



For control FZ diodes, full depletion voltage decreases from 340 V to 280 V after 200 Mrad radiation.

• C-V measurements MCZ:



For MCZ diodes, full depletion voltage increases from 370 V to 430 V after 200 Mrad radiation.

•TCT measurements (CFZ) 608 Mrad:

Laser on the p⁺ side (front side): + SC ~ 0



•TCT measurements (CFZ) 703 Mrad:

Laser on the p⁺ side (front side): - SC, Double peak/junction seen



•TCT measurements (CFZ) 608 Mrad:

Laser on the n⁺ side (back side): + SC ~ 0



•TCT measurements (CFZ) 703 Mrad:

Laser on the n⁺ side (back side): - SC, Double peak/junction seen



•TCT measurements (CFZ) 867 Mrad:

Laser on the p⁺ side (front side): - SC, Double peak/junction seen



•TCT measurements (CFZ) 1004 Mrad:

Laser on the p⁺ side (front side): - SC, Double peak/junction seen



•TCT measurements (CFZ) 867 Mrad:

Laser on the n⁺ side (back side): - SC, Double peak/junction seen



•TCT measurements (CFZ) 1004 Mrad:

Laser on the n⁺ side (back side): - SC, Double peak/junction seen



•TCT measurements (CFZ) 1177 Mrad:

Laser on the p⁺ side (front side): - SC, Double peak/junction seen

c:\data\mcz-9-02\1177mrad\t15-41f2.tct 01-10-2003 14:05:12 HV 9.59 D.47 -197.365 18.00 -227.468 28.00 2. -247.671 499V 16.00 26.00 3. -267.790 24.00 14.00 -297.954 5. 22.00 -328.032 12.00 20.00 -348.078 7. 18.00 10.00 -368.256 499 V 16.00 -378.345 8.00 14.00 -388.417 12.00 6.00 -398.463 11 10.00 -408.580 4.00 8.00 -418.537 13 6.00 2.00 14 -428.607 4.00 15 -438.702 0.00 2.00 248V-2.00 -448.711 0.00 248 V -458.728 17. -2.00 197 V .3.78 -468.772 18 -478.733 19 640 660 670 680 690 650 -498.767 20

•TCT measurements (CFZ) 1177 Mrad:

Laser on the n⁺ side (back side): - SC, Double peak/junction seen



For CFZ diodes after gamma radiation:

- o SCSI clearly observed ----- negative space charge build-up
- o SCSI taking place between 600 to 700 Mrad
- o **DJ/DP clearly observed after SCSI**

•TCT measurements (MCZ) 284 Mrad:

•TCT measurements (MCZ) 284 Mrad:

Laser on the n⁺ side (back side): + SC







For MCZ diodes after gamma radiation:

- o No SCSI observed up to 1.2 Grad ----- no net negative space charge build-up
- o V_{fd} increases with dose: net positive space charge build-up
- o No DJ/DP observed up to 1.2 Grad

•Comparison of CFZ and MCZ detectors after gamma radiation to 1177 Mrad:

Laser on the p⁺ side (front side), electron drift current

•TCT measurements (CFZ) 1177 Mrad:

Laser on the p⁺ side (front side): - SC, Double peak/junction seen Laser on the p⁺ side (front side): + SC HV 1. -99.8182 c:\data\mcz-9-02\1177mrad\t15-41f2.tct 01-10-2003 14:05:12 HV c:\data\mcz-9-02\1177mrad\o6-40f1.tct 01-10-2003 13:28:18 2. -299.781 0.47 -197.365 4.9 3. -499.744 -227.468 28.00 32.5 4. -599.659 -247.671 26.00 30.0 267.790 5. -649.677 24.00 27.5 -297.954 22.00 6. -669.672 25.0 -328.032 20.00 7. -699.719 22.5 -348.078 18.00 8. -729.711 20.0 -368.256 499 V 16.00 9. -749.675 -378.345 17.5 14.00 10. -769.613 -388.41999 15.0 12.00 11. -799.578 398,463 11 12.5 10.00 12. -819.616 -408.580 8.00-10.0 13. -839.591 -418.537 6.00 -7.5 -428.607 14. -859.598 4.00 --438.702750 V5.0 15. -879.518 2.00 -2.5 -448.711 0.00 16. -899.451 -458.728 0.0 248 V -2.00 17. -929.416 -468.772 197 V -3.78-99.8 ¥.8-18. -969.372 10 640 650 660 670 680 690 645 640 650 655 660 665 670 675 680 685 690 695 -498.767 19. -969.343

•TCT measurements (MCZ) 1177 Mrad:

20. -999.338

•Comparison of CFZ and MCZ detectors after gamma radiation to 1177 Mrad:

Laser on the n⁺ side (back side), hole drift current

•TCT measurements (CFZ) 1177 Mrad:





Negative SC build-up for control FZ Si detectors is: -1.82x10⁹ x Dose Positive SC build-up for Oxy Si detectors is: 4.1 x10⁸ Dose Positive SC build-up for MCZ Si detectors is: 2.9 x10⁹ x Dose, about 8 times higher



The model:

$$N_{eff} = N^0_{_{eff}} + \beta_{\gamma} \cdot \Phi_{\gamma}$$

where the introduction rate β_{γ} is :

$$\beta_{\gamma} = \kappa \{ [O] - [O]_0 \}$$

and [O] is the oxygen concentration,

 κ and $[O]_0$ are constants

The value of $[O]_0$ should be:

 $[O]_{\rm CFZ} < [O]_0 < [O]_{\rm Oxy} < [O]_{\rm MCZ}$ and in the order of high 10¹⁶/cm³

So the perfect oxygenated material is when $[O]_{Oxy} = [O]_0$ Then we have a beta zero material for gamma radiation



Neutron Radiation



• TCT measurements (MCZ):1.7x10¹³ n/cm² Laser on the p⁺ side (front side): +SC



• TCT measurements (MCZ):1.7x10¹³ n/cm² Laser on the n⁺ side (back side): +SC





• TCT measurements (MCZ):3.3x10¹³ n/cm² Laser on the p⁺ side (front side): +SC

-2.00

-3.65 -

640

650

660

6.8 V



680

690

670

• TCT measurements (MCZ):3.3x10¹³ n/cm²

Laser on the n⁺ side (back side): +SC



• TCT measurements (MCZ):8.2x10¹³ n/cm² Laser on the n⁺ side (back side): -SC





- For MCZ Si detectors, SCSI takes place between 3.3x10¹³ n/cm² and 8.2x10¹³ n/cm² after 1 MeV neutron radiation.
- Double junction and double peak (DJ/DP) have been observed after SCSI

• TCT measurements (CFZ): 1.7x10¹³ n/cm² Laser on the p⁺ side (front side): +SC



• TCT measurements (CFZ): 3.3x10¹³ n/cm² Laser on the p⁺ side (front side): -SC and DJ/DP



• TCT measurements (CFZ): 1.7x10¹³ n/cm² Laser on the n⁺ side (back side): +SC



• TCT measurements (CFZ): 3.3x10¹³ n/cm² Laser on the n⁺ side (back side): -SC



• TCT measurements (CFZ): 8.2x10¹³ n/cm² Laser on the p⁺ side (front side): -SC and DJ/DP

• TCT measurements (CFZ): 8.2x10¹³ n/cm² Laser on the n⁺ side (back side): -SC



• TCT measurements (CFZ): 2.9x10¹⁴ n/cm² Laser on the p⁺ side (front side): -SC and DJ/DP



Full depletion voltage vs. n-fluence





N_{eff} vs. n-fluence

Neff (1/cm3)



Proton Radiation

• TCT measurements (MCZ): 10 MeV protons, 3.0x10¹³ p/cm² Laser on the p⁺ side (front side): +SC, DJ barely seen



• TCT measurements (MCZ): 10 MeV protons, 5.9x10¹³ p/cm² Laser on the p⁺ side (front side): close to 0 SC, DJ/DP seen



• TCT measurements (MCZ): 10 MeV protons, 3.0x10¹³ p/cm² Laser on the n⁺ side (back side): +SC, DJ barely seen



• TCT measurements (MCZ): 10 MeV protons, 5.9x10¹³ p/cm² Laser on the n⁺ side (back side): 0 to - SC, DP seen





- For MCZ Si detectors, SCSI takes place around 5.9x10¹³ p/cm² after 10 MeV proton radiation.
- Double junction and double peak (DJ/DP) have been observed after SCSI

Proton Radiation (20 MeV)

• TCT measurements (MCZ): 20 MeV protons, 3.0x10¹³ p/cm²



• TCT measurements (MCZ): 20 MeV protons, 5.9x10¹³ p/cm² Laser on the p⁺ side (front side): +SC



• TCT measurements (MCZ): 20 MeV protons, 3.0x10¹³ p/cm² Laser on the n⁺ side (back side): +SC



 TCT measurements (MCZ): 20 MeV protons, 5.9x10¹³ p/cm² Laser on the n⁺ side (back side): +SC





- For MCZ Si detectors, SCSI takes place between 5.9x10¹³ p/cm² to 1.2x10¹⁴ p/cm² after 20 MeV proton radiation.
- Double junction and double peak (DJ/DP) have been observed after SCSI

N_{eff} vs. 1 MeV equivalent n-fluence



Comparison of N_{eff} vs. 1 MeV equivalent n-fluence between neutron and proton radiations



1 MeV equivalent n- Fluence (1E13 n/cm2)

Neff (1/cm3)

 $\begin{array}{c} \textbf{O} \ \textbf{CZ} \ \textbf{Si} \ \textbf{detectors} \ \textbf{are slightly more rad-hard than FZ ones with n-rad} \\ \beta_{CZ} \ (\textbf{b} \ \textbf{in the figure}) \ \textbf{is about 23\% less than } \beta_{FZ} \\ \textbf{o} \ \textbf{CZ} \ \textbf{Si} \ \textbf{detectors} \ \textbf{are much more rad-hard than FZ ones with p-rad} \\ \beta_{CZ} \ \textbf{is about 1/5 of } \beta_{FZ} \ \textbf{and is about 1/2 of } \beta_{OXY} \\ \textbf{SCSI fluence is 3 time higher than that of FZ} \end{array}$

- With higher [O], MCZ Si has more un-activated TD's
 - **Produced during the TD killing process**
- Gamma radiation activates those un-activated TD's, giving rise to the higher positive SC build-up rate
- This positive SC build-up may also happen in charged particle irradiated MCZ Si detectors, giving possibility of compensating regular negative SC ---- improvement of rad-hardness
- The degree of this improvement in rad-hardness may depend type of particle radiation

Summary

o Experimental results indicates that, upon gamma radiation, the MCZ Si detectors behave similarly to oxygenated Si detectors

- Positive SC build-up
- No SCSI

o The build-up rate positive SC in gamma irradiated Si detectors is higher than that in oxygenated Si detectors, and is proportional to [O]

- Much higher [O] in MCZ
- Even higher concentration of un-activated TD
- o Gamma-induced activation of TD's may be responsible

o MCZ Si detectors are also partially rad-hard to charge particles (protons in our case) and are more rad-hard than oxygenated Si detectors, and may be slightly radiation hard to neutrons than CFZ Si detectors.